

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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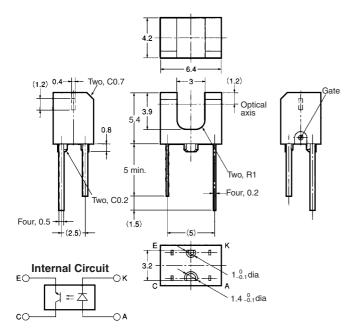
Photomicrosensor (Transmissive) **FF-SX1106**



Be sure to read Precautions on page 25.

Dimensions

Note: All units are in millimeters unless otherwise indicated.



Terminal No.	Name
Α	Anode
K	Cathode
С	Collector
E	Emitter

Unless otherwise specified, the tolerances are ± 0.2 mm.

■ Features

- Ultra-compact with a slot width of 3 mm.
- PCB mounting type.
- High resolution with a 0.4-mm-wide aperture.

■ Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Rated value
Emitter	Forward current	I _F	50 mA (see note 1)
	Pulse forward cur- rent	I _{FP}	
	Reverse voltage	V_R	5 V
Detector	Collector-Emitter voltage	V _{CEO}	30 V
	Emitter-Collector voltage	V _{ECO}	4.5 V
	Collector current	I _C	30 mA
	Collector dissipa- tion	P _C	80 mW (see note 1)
Ambient tem-	Operating	Topr	–25°C to 85°C
perature	Storage	Tstg	–30°C to 85°C
Soldering temperature		Tsol	260°C (see note 2)

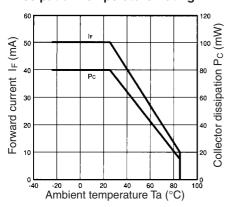
- Note: 1. Refer to the temperature rating chart if the ambient temperature exceeds 25°C.
 - 2. Complete soldering within 3 seconds.

■ Electrical and Optical Characteristics (Ta = 25°C)

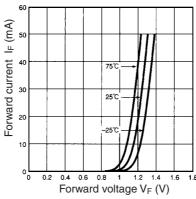
Item		Symbol	Value	Condition
Emitter	Forward voltage	V _F	1.3 V typ., 1.6 V max.	I _F = 50 mA
	Reverse current	I _R	10 μA max.	V _R = 5 V
	Peak emission wavelength	λ_{P}	950 nm typ.	I _F = 50 mA
I I G a	Light current	IL	0.2 mA min.	$I_F = 20 \text{ mA}, V_{CE} = 5 \text{ V}$
	Dark current	I _D	500 nA max.	V _{CE} = 10 V, 0 ℓx
	Leakage current	I _{LEAK}		
	Collector–Emitter saturated voltage	V _{CE} (sat)	0.4 V max.	$I_F = 20 \text{ mA}, I_L = 0.1 \text{ mA}$
	Peak spectral sensitivity wave- length	λ_{P}	800 nm typ.	V _{CE} = 5 V
Rising time		tr	10 μs typ.	V_{CC} = 5 V, R_L = 100 Ω , I_F = 20 mA
Falling time		tf	10 μs typ.	$V_{CC} = 5 \text{ V, R}_{L} = 100 \Omega,$ $I_{F} = 20 \text{ mA}$

■ Engineering Data

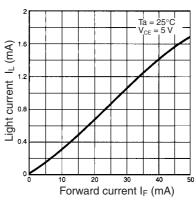
Forward Current vs. Collector Dissipation Temperature Rating



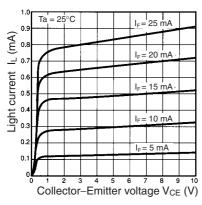
Forward Current vs. Forward **Voltage Characteristics (Typical)**



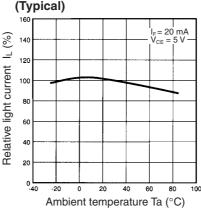
Light Current vs. Forward Current Characteristics (Typical)



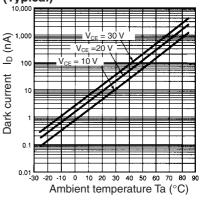
Light Current vs. Collector–Emitter Voltage Characteristics (Typical)



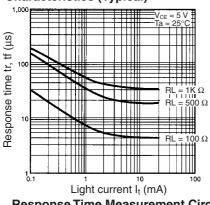
Relative Light Current vs. Ambient Temperature Characteristics



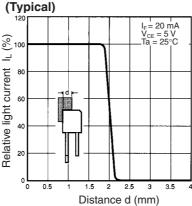
Dark Current vs. Ambient Temperature Characteristics (Typical)



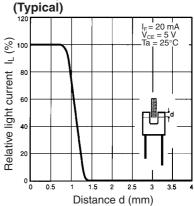
Response Time vs. Light Current Characteristics (Typical)



Sensing Position Characteristics



Sensing Position Characteristics



Response Time Measurement Circuit

Input o

